

SK32BF THRU SK320BF SCHOTTKY RECTIFIER



Features

- Metal silicon junction, majority carrier conduction
- For surface mounted applications
- Low power loss, high efficiency
- High forward surge current capability
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications
- This is a Pb – Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Circuit Diagram



Mechanical Data

- Case: SMBF
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 0.057g

Maximum Ratings and Electrical Characteristics @T_A=25°C unless otherwise specified

Characteristic	Symbol	SK32 BF	SK34 BF	SK36 BF	SK38 BF	SK310 BF	SK312 BF	SK315 BF	SK320 BF	Units
Peak Repetitive Reverse Voltage DC Blocking Voltage	V _{RRM} V _{DC}	20	40	60	80	100	120	150	200	V
Maximum RMS voltage	V _{RMS}	14	28	42	56	70	84	105	140	V
Maximum Average Forward Rectified Current	I _{F(AV)}	3.0								A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	80				70				A
Max Instantaneous Forward Voltage at 2 A	V _F	0.55	0.70		0.85		0.95		V	
Peak Reverse Current At Rated DC Blocking Voltage	I _{RM}	0.5 5 /				0.3 / 5				mA
Typical Thermal Resistance Junction to Ambient (Note 1)	R _{θJA}	50								°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150								°C

Note: 1. P.C.B. mounted with 0.5 X 0.5" (12.7 X 12.7 mm) copper pad areas.

Ratings and Characteristics Curves

Fig.1 Forward Current Derating Curve

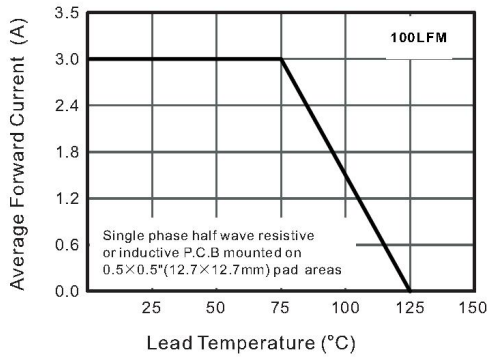


Fig.2 Typical Reverse Characteristics

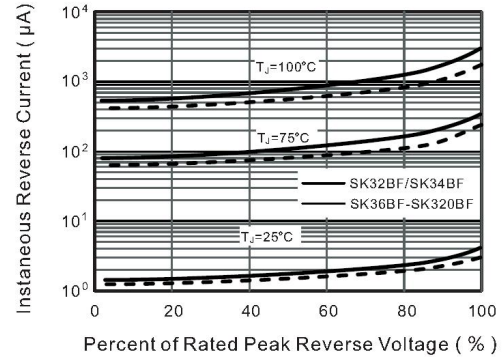


Fig.3 Typical Forward Characteristic

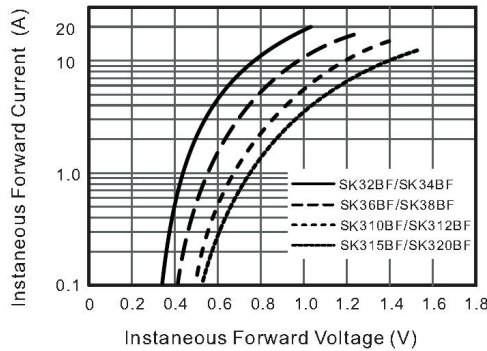


Fig.4 Maximum Non-Repetitive Peak Forward Surge Current

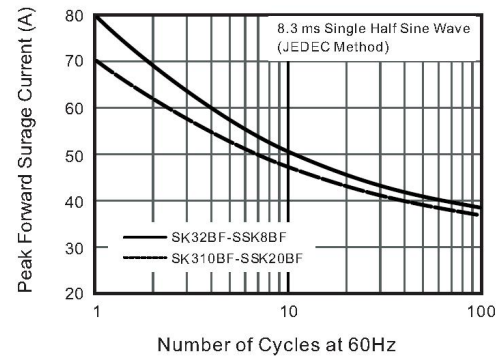
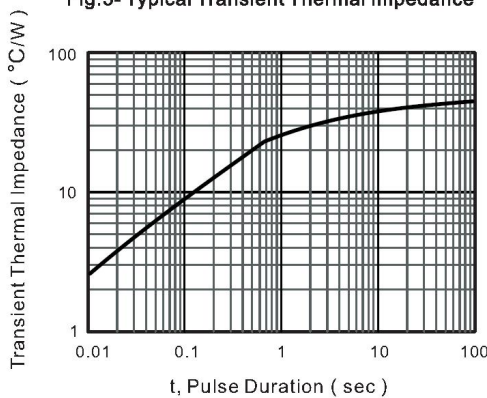
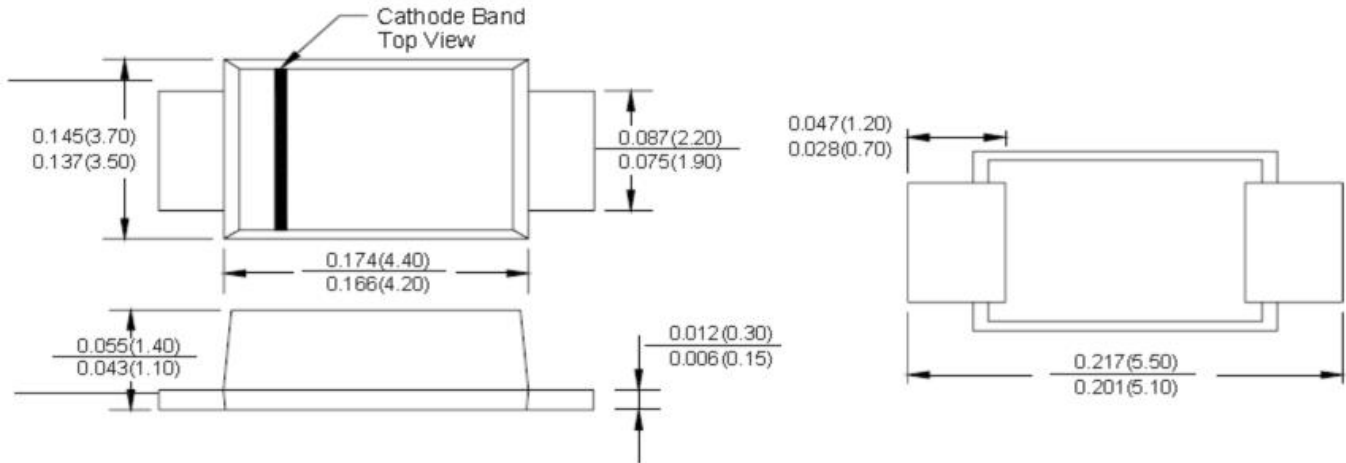


Fig.5- Typical Transient Thermal Impedance



Mechanical Dimensions SMBF(Inches/Millimeters)



Ordering Information

Device	Package	Shipping
SK32BF THRU SK320BF	SMBF (Pb-Free)	5000pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

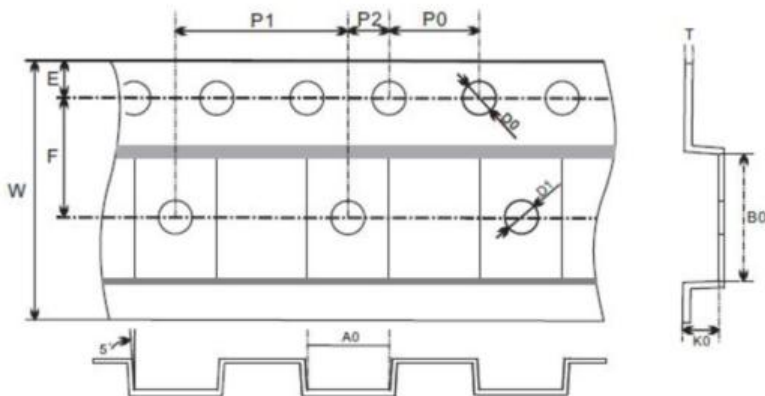
Marking Diagram



Where XXXXX is YYWWL

SK32BF = Part Name
YY = Year
WW = Week
L = Lot Number

Carrier Tape Specification SMBF



SYMBOL	Millimeters	
	Min.	Max.
A0	3.70	3.90
B0	5.65	5.85
K0	1.30	1.50
P0	3.90	4.10
P1	7.90	8.10
P2	1.90	2.10
T	0.23	0.27
E	1.65	1.85
F	5.45	5.65
D0	1.50	1.60
D1	1.50	1.60
W	11.90	12.10



SK32BF
THRU
SK320BF

Technical Data
Data Sheet N1688 Rev. A



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